

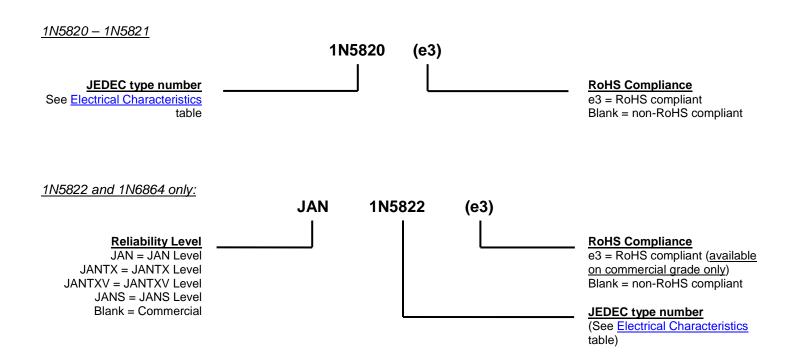
MECHANICAL and PACKAGING

- CASE: Hermetically sealed voidless hard glass with tungsten slugs.
- TERMINALS: Tin/lead or RoHS compliant matte/tin on commercial grade only (no JAN levels) over nickel plate over copper.
- MARKING: Body coated in blue with part number.
- POLARITY: Cathode indicated by band.

🌽 Microsemi.

- TAPE & REEL option: Standard per EIA-296. Consult factory for quantities.
- WEIGHT: Approximately 750 milligrams.
- See <u>Package Dimensions</u> on last page.

PART NOMENCLATURE



SYMBOLS & DEFINITIONS									
Symbol	Definition								
Ст	Capacitance: The capacitance in pF at a frequency of 1 MHz and specified voltage.								
f	frequency								
I _R	Maximum Reverse Current: The maximum reverse (leakage) current that will flow at the specified voltage and temperature.								
lo	Average Rectified Output Current: The output current averaged over a full cycle with a 50 Hz or 60 Hz sine-wave input and a 180 degree conduction angle.								
VF	Maximum Forward Voltage: The maximum forward voltage the device will exhibit at a specified current.								
V _R	Reverse Voltage: The dc voltage applied in the reverse direction below the breakdown region.								
V _{RWM}	Working Peak Reverse Voltage: The maximum peak voltage that can be applied over the operating temperature range.								



TYPE NUMBER	WORKING PEAK REVERSE VOLTAGE	MAXIMUM FORWARD VOLTAGE V _{FM1}	MAXIMUM FORWARD VOLTAGE V _{FM2}	MAXIMUM FORWARD VOLTAGE V _{FM3}	MAXIMUM REVERSE LEAKAGE CURRENT I _{RM} @ V _{RM}	
	V _{RWM}	I _{FM} = 1.0 A	I _{FM} = 3.0 A	I _{FM} = 9.4 A	T」= +25 ℃	T _J = +100 °C
	V (pk)	Volts	Volts	Volts	mA	mA
1N5820	20	0.40	0.50	0.70	0.10 @ 20 V	12.5 @ 20 V
1N5821	30	0.40	0.50	0.70	0.10 @ 30 V	12.5 @ 30 V
1N5822	40	0.40	0.50	0.70	0.10 @ 40 V	12.5 @ 40 V
1N6864	80	0.50	0.70	N/A	0.15 @ 80 V	18.0 @ 80 V

ELECTRICAL CHARACTERISTICS @ 25 °C unless otherwise noted.



GRAPHS

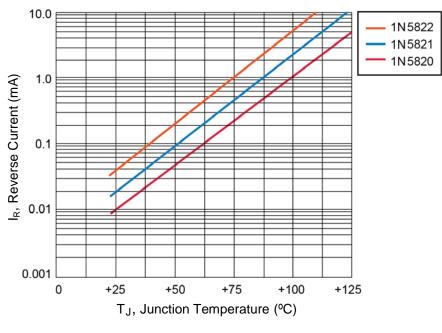
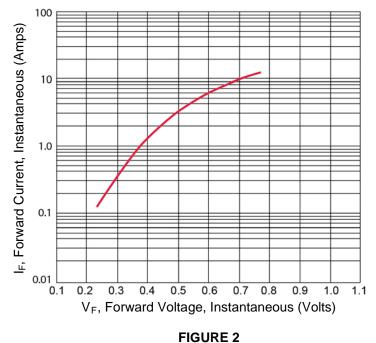


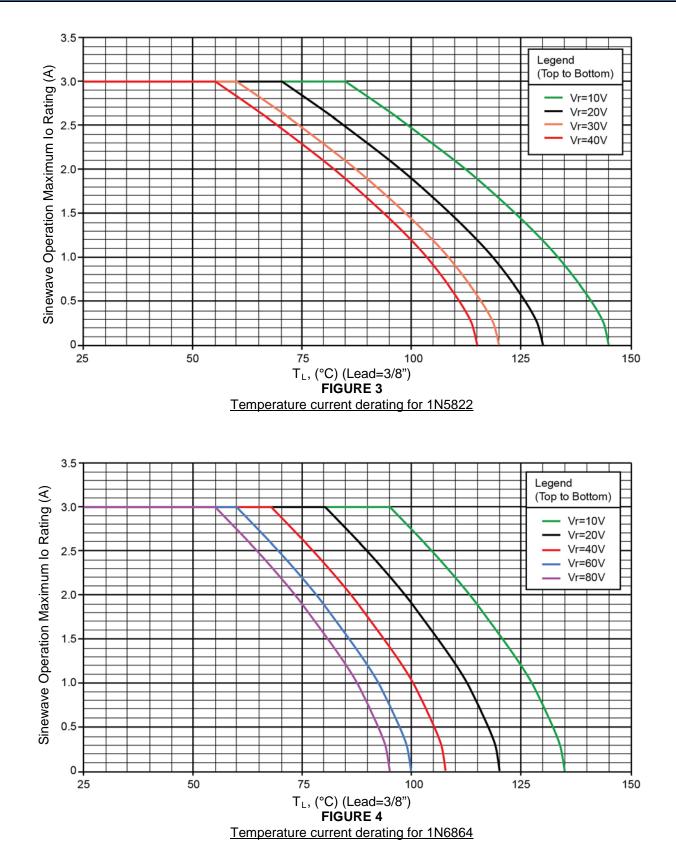
FIGURE 1 Typical Reverse Leakage Current at Rated PIV (PULSED)



Typical Forward Voltage

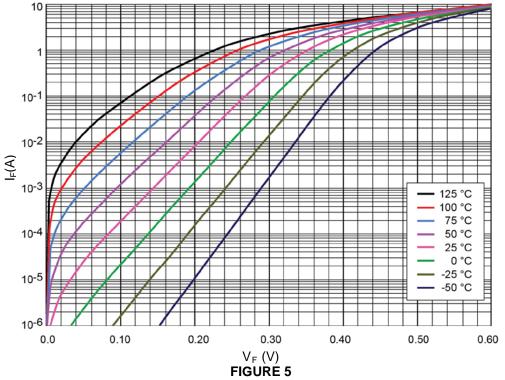


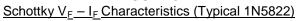
GRAPHS (continued)

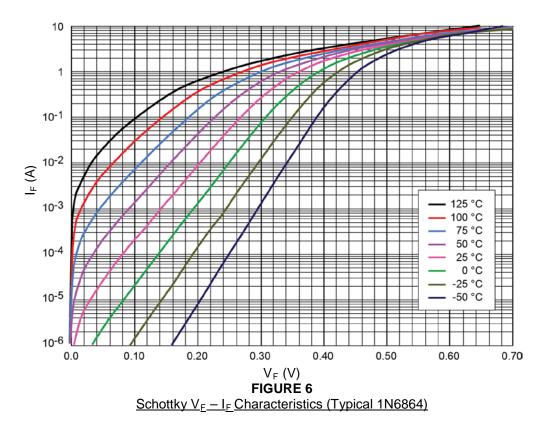




GRAPHS (continued)

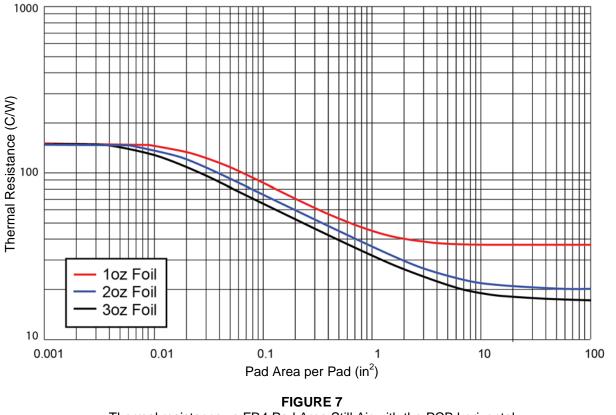








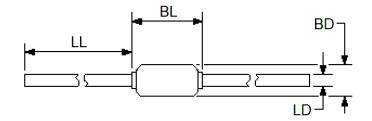
GRAPHS (continued)



Thermal resistance vs FR4 Pad Area Still Air with the PCB horizontal (At lead length = 0.187 inch)



PACKAGE DIMENSIONS



NOTES:

- 1. Dimensions are in inches.
- 2. Millimeters are given for information only.
- Dimension BL shall include the entire body including slugs and sections of the lead over which the diameter is uncontrolled. This uncontrolled area is defined as the zone between the edge of the diode body and extending .050 inch (1.27 mm) onto the leads.
- 4. Dimension BD shall be measured at the largest diameter.
- 5. In accordance with ASME Y14.5M, diameters are equivalent to Φx symbology.

Ltr	INCH		MILLIM	Notes	
	Min	Max	Min	Max	
BD	0.115	0.142	2.92	3.61	4
BL	0.130	0.300	3.30	7.62	3
LD	0.036	0.042	0.91	1.07	3
LL	0.900	1.30	22.86	33.02	

Lead Tolerance = +.002 - .003 in.

(Includes sections of the lead or fillet over which the lead diameter is uncontrolled.)

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Microsemi:

<u>1N6864</u> <u>JANTXV1N5822</u> <u>1N6864/TR</u> <u>JANTX1N5822/TR</u> <u>JANTXV1N5822/TR</u> <u>JAN1N5822/TR</u> <u>1N5822</u>/TR